Electronic Patent Application Fee Transmittal							
Application Number:	100	10696198					
Filing Date:	28-	28-Oct-2003					
Title of Invention:	Mu	Multi-chip package device with heat sink and fabrication method thereof					
First Named Inventor/Applicant Name:	Chi	Chien-Ping Huang					
Filer:	Ste	Steven M. Jensen					
Attorney Docket Number:	601	60173(71987)					
Filed as Large Entity	•						
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:					1		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	120	120		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Total in USD (\$)			930